**IRF610** 

Vishay Siliconix



**TO-220AB** 

**PRODUCT SUMMARY** 

V<sub>DS</sub> (V)

R<sub>DS(on)</sub> (Ω)

Q<sub>gs</sub> (nC)

Q<sub>gd</sub> (nC)

Q<sub>a</sub> max. (nC)

Configuration

# **Power MOSFET**

### **FEATURES**

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- Fast switching
- · Ease of paralleling
- Simple drive requirements
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### Note

S

N-Channel MOSFET

1.5

200

8.2

1.8

4.5

Single

 $V_{GS} = 10 V$ 

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

#### DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRF610PbF			
Lead (Pb)-free and halogen-free	IRF610PbF-BE3			

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \degree C$ , unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	200	V	
Gate-source voltage			V <sub>GS</sub>	± 20	V	
Continuous drain aurrant	$V_{GS} \text{ at } 10 \text{ V} \qquad \frac{\text{T}_{\text{C}} = 25 \text{ °C}}{\text{T}_{\text{C}} = 100 \text{ °C}}$	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	3.3		
Continuous drain current		T <sub>C</sub> = 100 °C		2.1	А	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	10		
Linear derating factor				0.29	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	64	mJ	
Repetitive avalanche current <sup>a</sup>			I <sub>AR</sub>	3.3	А	
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	3.6	mJ	
Maximum power dissipation	imum power dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$			36	W	
Peak diode recovery dV/dt <sup>c</sup>			dV/dt	5.0	V/ns	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering recommendations (peak temperature) <sup>d</sup>	For 10 s			300	7	
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting torque				1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 8.8 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 3.3 A (see fig. 12)

c.  $I_{SD} \le 3.3$  A, dl/dt  $\le 70$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C

d. 1.6 mm from case

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THERMAL RESISTANCE RATINGS									
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum junction-to-ambient	R <sub>thJA</sub>	-		62					
Case-to-sink, flat, greased surface	R <sub>thCS</sub>	0.50 -			°C/W				
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-		3.5					
		•							
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ ,	unless otherw	ise noted)							
PARAMETER	SYMBOL	-	CONDITIC	ONS	MIN.	TYP.	MAX.	UNIT	
Static	4	1				Į			
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0	V, I <sub>D</sub> = 25	i0 μA	200	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference t	to 25 °C, I <sub>l</sub>	$_{\rm D} = 1  \rm{mA}$	-	0.30	-	V/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V	<sub>GS</sub> , I <sub>D</sub> = 25	50 µA	2.0	-	4.0	V	
Gate-source leakage	I <sub>GSS</sub>		<sub>S</sub> = ± 20 V		-	-	± 100	nA	
		$V_{DS} = 2$	00 V, V <sub>GS</sub>	= 0 V	-	-	25		
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 160 V, V	/ <sub>GS</sub> = 0 V,	T <sub>J</sub> = 125 °C	-	-	250	μA	
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub>	= 2.0 A <sup>b</sup>	-	-	1.5	Ω	
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 50	0 V, I <sub>D</sub> = 2	.0 A <sup>b</sup>	0.8	-	-	S	
Dynamic						•	•	•	
Input capacitance	C <sub>iss</sub>	V	<sub>GS</sub> = 0 V,		-	140	-		
Output capacitance	C <sub>oss</sub>	V	$V_{DS} = 25 V,$		-	53	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1.0 MHz, see fig. 5		-	15	-			
Total gate charge	Qg				-	-	8.2	nC	
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 V$		A, $V_{DS} = 160 V$ , g. 6 and 13 <sup>b</sup>	-	-	1.8		
Gate-drain charge	Q <sub>gd</sub>	]	300 110	j. o and to	-	-	4.5		
Turn-on delay time	t <sub>d(on)</sub>		V <sub>DD</sub> = 100 V, I <sub>D</sub> = 3.3 A,		-	8.2	-		
Rise time	t <sub>r</sub>				-	17	-		
Turn-off delay time	t <sub>d(off)</sub>	$R_g = 24 \Omega, R_E$	$_{0} = 30 \ \Omega, s$	ee fig. 10 <sup>b</sup>	-	14	-	ns	
Fall time	t <sub>f</sub>				-	8.9	-	1	
Gate input resistance	Rg	f = 1 M	f = 1 MHz, open drain		2.3	-	10.2	Ω	
Internal drain inductance	L <sub>D</sub>	6 mm (0.25") f	Between lead, 6 mm (0.25") from		-	4.5	-	nLl	
Internal source inductance	L <sub>S</sub>	package and center of die contact		-	7.5	-	nH		
Drain-Source Body Diode Characterist	ics								
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	3.3	^		
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>			-	-	10	A		
Body diode voltage	V <sub>SD</sub>	$T_{J} = 25 \ ^{\circ}C, I_{S} = 3.3 \ A, V_{GS} = 0 \ V^{b}$		-	-	2.0	V		
Body diode reverse recovery time	t <sub>rr</sub>	$T_{\rm J} = 25 ^{\circ}\text{C}, I_{\rm F} = 3.3 \text{A}, \text{dI/dt} = 100 \text{A/}\mu\text{s}^{\text{b}}$		-	150	310	ns		
Body diode reverse recovery charge	Q <sub>rr</sub>			-	0.60	1.4	μC		
Forward turn-on time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-			-on is doi	minated b	y L <sub>S</sub> and	L <sub>D</sub> )	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width  $\leq 300~\mu s;~duty~cycle \leq 2~\%$ 

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

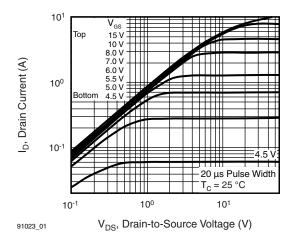


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

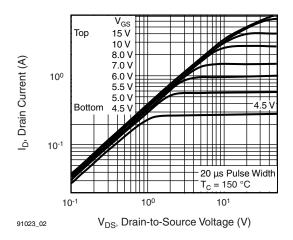
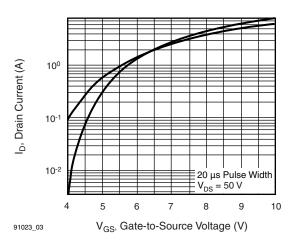


Fig. 2 - Typical Output Characteristics,  $T_C = 150$  °C





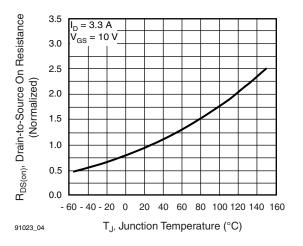


Fig. 4 - Normalized On-Resistance vs. Temperature

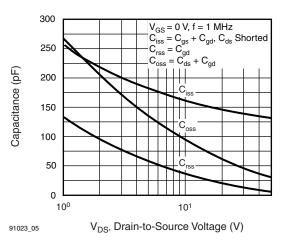


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

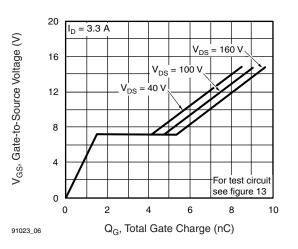


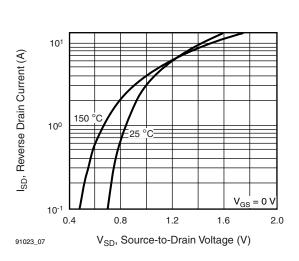
Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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Fig. 7 - Typical Source-Drain Diode Forward Voltage

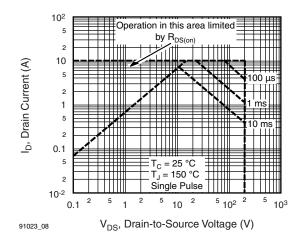


Fig. 8 - Maximum Safe Operating Area

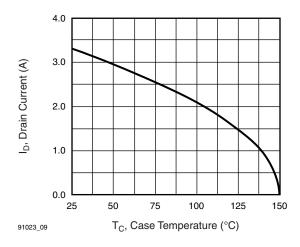


Fig. 9 - Maximum Drain Current vs. Case Temperature

 $V_{DS}$   $R_{D}$   $V_{GS}$  D.U.T.  $R_{G}$  D.U.T.  $Pulse width \le 1 \ \mu S$ Duty factor  $\le 0.1 \ \%$ 

Fig. 10a - Switching Time Test Circuit

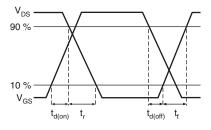
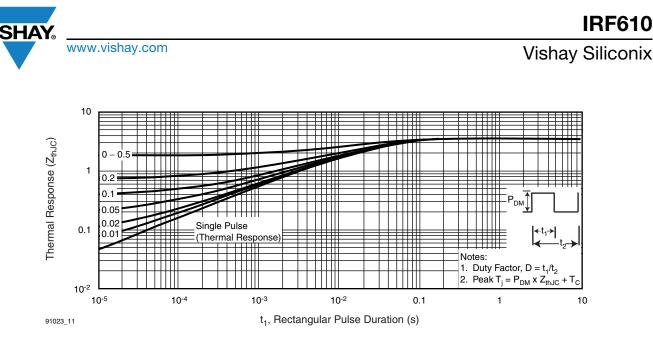


Fig. 10b - Switching Time Waveforms

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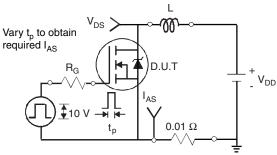
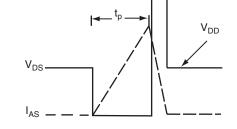


Fig. 12a - Unclamped Inductive Test Circuit



/<sub>DS</sub>

Fig. 12b - Unclamped Inductive Waveforms

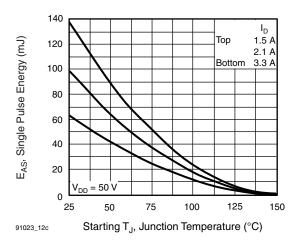
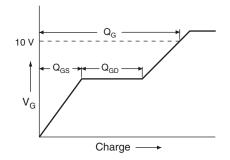


Fig. 12c - Maximum Avalanche Energy vs. Drain Current



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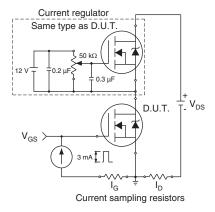
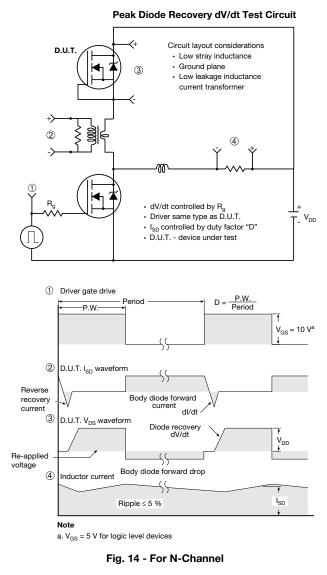


Fig. 13a - Basic Gate Charge Waveform

Fig. 13b - Gate Charge Test Circuit



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?91023">http://www.vishay.com/ppg?91023</a>.

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

-  $M^{\star}$  = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
ASE		Xi'an			
		IRF 9510 744K AB			

Revison: 14-Dec-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 66542

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